

① 6-09-03

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06/11/03

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT
(Under 37 CFR 1.97(b) or 1.97(c))

Docket No.
08228/019001

In Re Application Of: Shiro SAKAI et al.

O P E
JUN 06 2003
P A T E N T & T R A D E M A R K O F F I C E
S E R I E S

Serial No.
10/044,686

Filing Date
01/11/2002

Examiner

Group Art Unit
1765

Title: NITRIDE SEMICONDUCTOR CHIP AND METHOD FOR MANUFACTURING NITRIDE
SEMICONDUCTOR CHIP

RECEIVED
JUN 11 2003
GROUP 1700

Address to:

Assistant Commissioner for Patents
Washington, D.C. 20231

37 CFR 1.97(b)

1. The Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application; within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; or before the mailing date of a first Office Action on the merits, whichever event occurs last.

37 CFR 1.97(c)

2. The Information Disclosure Statement submitted herewith is being filed after three months of the filing of a national application, or the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; or after the mailing date of a first Office Action on the merits, whichever occurred last but before the mailing date of either:

1. a Final Action under 37 CFR 1.113, or
2. a Notice of Allowance under 37 CFR 1.311,

whichever occurs first.

Also submitted herewith is:

- a certification as specified in 37 CFR 1.97(e);

OR

- the fee set forth in 37 CFR 1.17(p) for submission of an Information Disclosure Statement under 37 CFR 1.97(c).

CERTIFICATE OF MAILING BY "EXPRESS MAIL" (37 CFR 1.10)

Applicant(s): Shiro SAKAI et al.

Docket No.

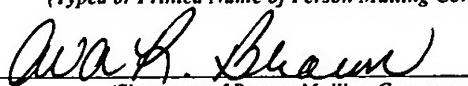
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Group Art Unit
1765Invention: NITRIDE SEMICONDUCTOR CHIP AND METHOD FOR MANUFACTURING NITRIDE
SEMICONDUCTOR CHIP*RECEIVED
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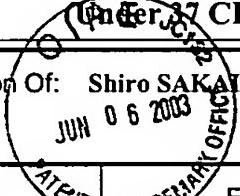
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Payment of Fee

(Only complete if Applicant elects to pay the fee set forth in 37 CFR 1.17(p))

- A check in the amount of _____ is attached.
- The Assistant Commissioner is hereby authorized to charge and credit Deposit Account No. 50-0591 as described below. A duplicate copy of this sheet is enclosed.
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